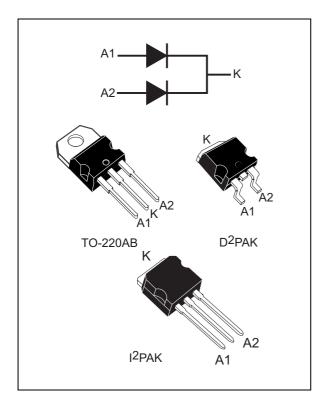


# FERD30M45C

# Field effect rectifier

### Datasheet - production data



# **Features**

- Advanced rectifier proprietary process
- Stable leakage current over reverse voltage
- Reduce leakage current
- Low forward voltage drop
- High frequency operation

# Description

This dual center tap field effect rectifier provides stable leakage current over the full range of reverse voltage and low forward voltage drop.

Packaged in TO-220AB, I<sup>2</sup>PAK or D<sup>2</sup>PAK, this device is intended to be used in solar bypass junction boxes and in switch mode power supplies.

Table	1.	Device	summary

Symbol	Value
I <sub>F(AV)</sub>	2 x 15 A
V <sub>RRM</sub>	45 V
T <sub>j (max)</sub>	+175 °C (up to 200 °C forward mode only on D <sup>2</sup> PAK)
V <sub>F</sub> (typ)	0.35 V

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This is information on a product in full production.

# 1 Characteristics

### Table 2. Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Paramet		Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage			45	V
I <sub>F(RMS)</sub>	Forward rms current			30	А
	Average forward current, $\delta = 0.5$	T <sub>c</sub> = 155 °C	Per diode	15	А
I <sub>F(AV)</sub>	Average forward current, 0 = 0.5	T <sub>c</sub> = 155 °C	Per device	30	~
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$				А
T <sub>stg</sub>	Storage temperature range			-65 to + 175	°C
Τ <sub>j</sub>	Maximum operating junction temperature			175	°C
Тj	Maximum operating temperature on D <sup>2</sup> PAK (DC forward current without reverse bias, t = -	1 hour) <sup>(1)</sup>		200	°C

 $1. \quad \frac{dPtot}{dTj} < \frac{1}{Rth(j-a)} \text{ condition to avoid thermal runaway for a diode on its own heatsink.}$ 

### Table 3. Thermal resistance

Symbol	Parameter	Value (max)	Unit	
Б	Junction to case	Per diode	1.6	
R <sub>th(j-c)</sub>		Total	1.05	°C/W
R <sub>th(c)</sub>	Coupling		0.5	

When diodes 1 and 2 are used simultaneously:

 $T_j(diode 1) = P(diode1) \times R_{th(j-c)}(per diode) + P(diode2) \times R_{th}(c)$ 



Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>						600	μA
IR` ′	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 125 °C	$V_R = V_{RRM}$		25	50	mA
	V (2) Forward valte as drag	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 7.5 A		0.305	0.350	
V <sub>F</sub> <sup>(2)</sup>		T <sub>j</sub> = 125 °C	I <sub>F</sub> = 10 A		0.350	0.395	V
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 15 A		0.420	0.470	v
		T <sub>j</sub> = 125 °C	1 <sub>F</sub> – 13 A		0.420	0.450	

1. Pulse test:  $t_p = 5 \text{ ms}, \delta < 2\%$ 

2. Pulse test:  $t_p = 380 \ \mu s, \ \delta < 2\%$ 

To evaluate the conduction losses use the following equation:

 $P = 0.27 \text{ x } I_{F(AV)} + 0.012 I_{F}^{2}_{(RMS))}$ 



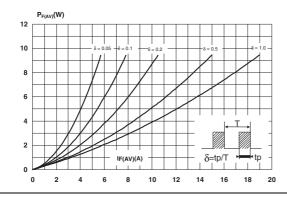


Figure 2. Average forward current versus ambient temperature ( $\delta$  = 0.5, per diode)

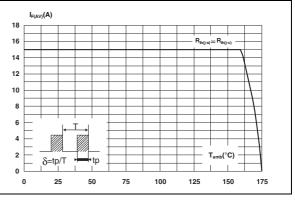
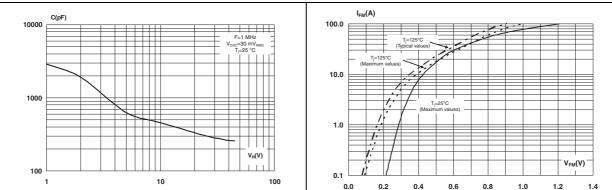


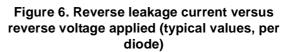
Figure 3. Junction capacitance versus reverse Figure 4. Forward voltage drop versus forward voltage applied (typical values, per diode)

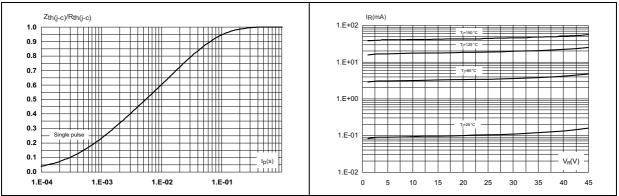
current (per diode)





# Figure 5. Relative variation of thermal impedance junction to case versus pulse duration



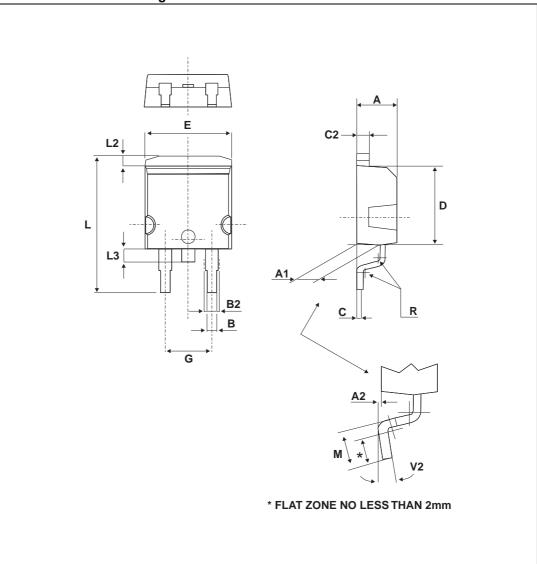




# 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 to 1.0 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.





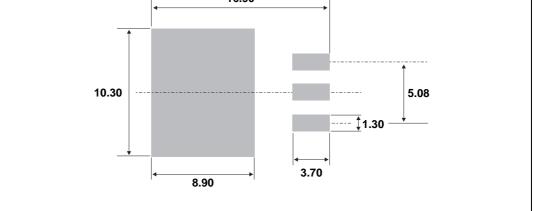


		Dimensions				
Ref.	Millin	Millimeters		nes		
	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
A1	2.49	2.69	0.098	0.106		
A2	0.03	0.23	0.001	0.009		
В	0.70	0.93	0.027	0.037		
B2	1.14	1.70	0.045	0.067		
С	0.45	0.60	0.017	0.024		
C2	1.23	1.36	0.048	0.054		
D	8.95	9.35	0.352	0.368		
Е	10.00	10.40	0.393	0.409		
G	4.88	5.28	0.192	0.208		
L	15.00	15.85	0.590	0.624		
L2	1.27	1.40	0.050	0.055		
L3	1.40	1.75	0.055	0.069		
М	2.40	3.20	0.094	0.126		
R	0.40 typ.		0.016	s typ.		
V2	0°	8°	0°	8°		

Table 5. D<sup>2</sup>PAK dimension values

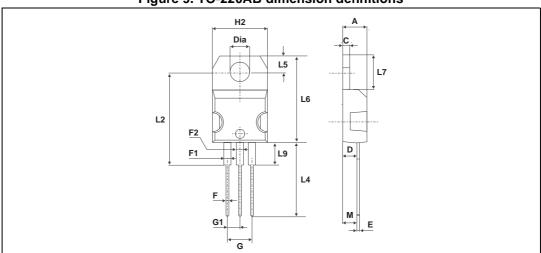
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### Figure 8. Footprint (dimensions in mm)





D

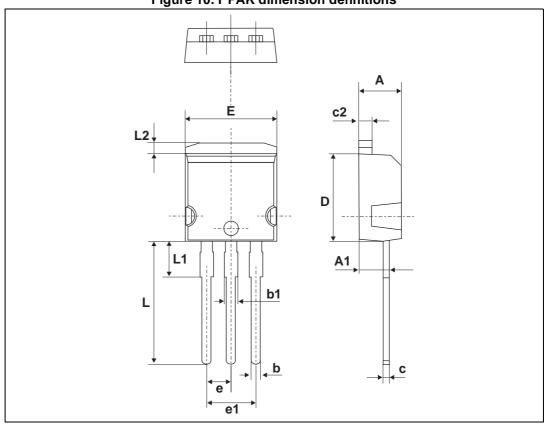


### Figure 9. TO-220AB dimension definitions

	Table 6. TO-220AB dimension values					
		Dimensions				
Ref.	Millim	neters	Incl	nes		
	Min.	Max.	Min.	Max.		
А	4.40	4.60	0.173	0.181		
С	1.23	1.32	0.048	0.051		
D	2.40	2.72	0.094	0.107		
Е	0.49	0.70	0.019	0.027		
F	0.61	0.88	0.024	0.034		
F1	1.14	1.70	0.044	0.066		
F2	1.14	1.70	0.044	0.066		
G	4.95	5.15	0.194	0.202		
G1	2.40	2.70	0.094	0.106		
H2	10	10.40	0.393	0.409		
L2	16.4	typ.	0.645 typ.			
L4	13	14	0.511	0.551		
L5	2.65	2.95	0.104	0.116		
L6	15.25	15.75	0.600	0.620		
L7	6.20	6.60	0.244	0.259		
L9	3.50	3.93	0.137	0.154		
М	2.6	typ.	0.102	2 typ.		
Diam.	3.75	3.85	0.147	0.151		







## Figure 10. I<sup>2</sup>PAK dimension definitions

## Table 7. I<sup>2</sup>PAK dimension values

	Dimensions				
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
A	4.40	4.60	0.173	0.181	
A1	2.40	2.72	0.094	0.107	
b	0.61	0.88	0.024	0.035	
b1	1.14	1.70	0.044	0.067	
с	0.49	0.70	0.019	0.028	
c2	1.23	1.32	0.048	0.052	
D	8.95	9.35	0.352	0.368	
е	2.40	2.70	0.094	0.106	
e1	4.95	5.15	0.195	0.203	
E	10	10.40	0.394	0.409	
L	13	14	0.512	0.551	
L1	3.50	3.93	0.138	0.155	
L2	1.27	1.40	0.050	0.055	



# **3** Ordering information

Table 8.	Ordering	information
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Order code	Marking	Package	Weight	Base qty	Delivery mode
FERD30M45CT	FERD30M45CT	TO-220AB	2.2 g	50	Tube
FERD30M45CG-TR	FERD30M45CG	D <sup>2</sup> PAK	1.5 g	1000	Tape and reel
FERD30M45CR	FERD30M45CR	I <sup>2</sup> PAK	1.4 g	50	Tube

# 4 Revision history

Date	Revision	Changes
12-Nov-2012	1	Initial release.
12-Nov-2013	2	Updated title.
11-Jul-2014	3	Added I <sup>2</sup> PAK package.

### Table 9. Document revision history



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